

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Ano
Serial No: 10/017,737
Filed: 12/14/2001
For: STACKED IC PACKAGE

Docket No: TI-33183
Examiner: Lewis, Monica
Art Unit: 2822

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AMENDMENT UNDER 37 C.F.R. § 1.115

Assistant Commissioner For Patents
Washington, DC 20231

CERTIFICATION OF FACSIMILE TRANSMISSION

I hereby certify that the following papers are being
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Office at 703-872-9306 on 2-24-05:


Temie Chambers

Dear Sir:

Responsive to the Office Action mailed November 17, 2004 in connection with
the above identified application, Applicants respectfully submit the following remarks.

To: Technology Unit: 2822
Facsimile Number: 703-872-9306

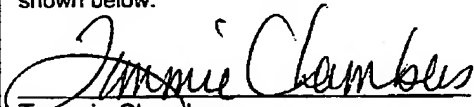
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<input checked="" type="checkbox"/> FACSIMILE COVER SHEET	<input checked="" type="checkbox"/> AMENDMENT (3 Pages)
<input type="checkbox"/> NEW APPLICATION	<input checked="" type="checkbox"/> EOT (1 Month)
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<input type="checkbox"/> DIVISIONAL APP'N	
NAME OF INVENTOR(S): Ano	
RECEIPT DATE & SERIAL NO.: Serial No.: 10/017,737	
Filing Date: 12/14/2001	
TITLE OF INVENTION:	
STACKED IC PACKAGE	
TI FILE NO.: TI-33183	DEPOSIT ACCT. NO.: 20-0668
FAXED: <u>2-24-05</u>	
DUE: 02/17/2005	
ATTY/SEC'Y: WDS/ltc	

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